HLMP-1301

T-1 (3 mm) Diffused LED Lamps

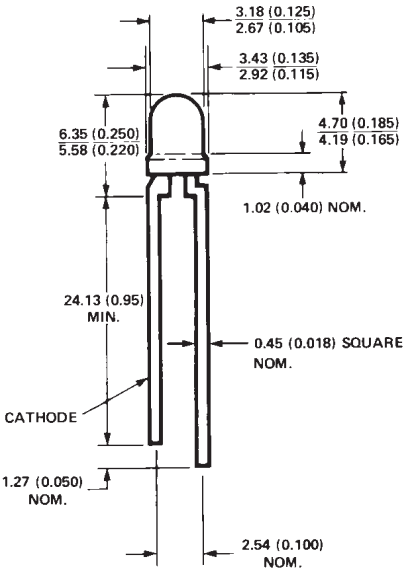
Data Sheet

HLMP-1301, HLMP-1401, HLMP-1503,
HLMP-K401, HLMP-K600

Description

This family of T-1 lamps is widely used in general purpose indicator applications. Diffusants, tints, and optical design are balanced to yield superior light output and wide viewing angles. Several intensity choices are available in each color for increased design flexibility.

Package Dimensions



NOTES:
1. ALL DIMENSIONS ARE IN MILLIMETRES (INCHES).
2. AN EPOXY MENISCUS MAY EXTEND ABOUT 1mm (0.040") DOWN THE LEADS.

Features

- **High intensity**
- **Choice of 4 bright colors**
  High Efficiency Red
  Orange
  Yellow
  High Performance Green
- **Popular T-1 diameter package**
- **Selected minimum intensities**
- **Wide viewing angle**
- **General purpose leads**
- **Reliable and rugged**
- **Available on tape and reel**

Selection Guide

Material	Color	Part Number	Luminous Intensity Iv (mcd) at 10 mA Min.	Max.
GaAsP on GaP	Red	HLMP-1301	3.4	–
		HLMP-1301-E00xx	3.4	–
		HLMP-1301-FG0xx	5.4	17.2
		HLMP-1301-G00xx	8.6	–
		HLMP-1301-GH0xx	8.6	27.6
	Yellow	HLMP-1401	2.2	–
		HLMP-1401-D00xx	3.6	–
		HLMP-1401-E00xx	5.7	–
		HLMP-1401-EF0xx	5.7	18.4
		HLMP-1401-EFBxx	5.7	18.4
	Orange	HLMP-K401	2.1	–
		HLMP-K401-E00xx	3.4	–
		HLMP-K401-EF0xx	3.4	10.8
		HLMP-K401-FGDxx	5.4	17.2
GaP	Green	HLMP-1503	1.0	–
		HLMP-1503-C00xx	2.6	–
		HLMP-1503-D00xx	4.2	–
		HLMP-1503-DE0xx	4.2	13.4
		HLMP-1503-DEDxx	4.2	13.4
	Emerald Green[1]	HLMP-K600	1.0	–

Note:
1. Please refer to Application Note 1061 for information comparing standard green and emerald green light output degradation.

Part Numbering System

HLMP - x x xx - x x x xx

Mechanical Option
00: Bulk
01: Tape & Reel, Crimped Leads
02, Bx: Tape & Reel, Straight Leads
A1: Right Angle Housing, Uneven Leads
A2: Right Angle Housing, Even Leads
Dx, EE: Ammo Pack, Straight Leads
R4: Tape & Reel, Counter Clockwise
Vx: Ammo Pack, Horizontal Leads
FG: Products need inventory control for Customer IDI

Color Bin Options
0: Full Color Bin Distribution
B: Color Bins 2 & 3 only
D: Color Bins 4 & 5 only

Maximum Iv Bin Options
0: Open (no max. limit)
Others: Please refer to the Iv Bin Table

Minimum Iv Bin Options
Please refer to the Iv Bin Table

Color Options
3: GaP HER
4: GaP Yellow (except K4xx Series)
5: GaP Green
6: GaP Emerald Green

Package Options
1: T-1 (3 mm)
K: T-1 (3 mm) Orange (K4xx) or Emerald Green (K6xx)

Absolute Maximum Ratings at $T_A = 25°C$

Parameter	HER/Orange	Yellow	Green	Units
Peak Forward Current	90	60	90	mA
Average Forward Current[1]	25	20	25	mA
DC Current[2]	30	20	30	mA
Reverse Voltage (I_R = 100 μA)	5	5	5	V
Transient Forward Current[4] (10 μsec Pulse)	500	500	500	mA
LED Junction Temperature	110	110	110	°C
Operating Temperature Range	-55 to +100	-55 to +100	-20 to +100	°C
Storage Temperature Range			-55 to +100	

Notes:

1. See Figure 5 (HER/Orange), 10 (Yellow), or 15 (Green/Emerald Green) to establish pulsed operating conditions.
2. For Red, Orange, and Green series derate linearly from 50°C at 0.5 mA/°C. For Yellow series derate linearly from 50°C at 0.2 mA/°C.
3. For Red, Orange, and Green series derate power linearly from 25°C at 1.8 mW/°C. For Yellow series derate power linearly from 50°C at 1.6 mW/°C.
4. The transient peak current is the maximum non-recurring peak current that can be applied to the device without damaging the LED die and wirebond. It is not recommended that the device be operated at peak currents beyond the peak forward current listed in the Absolute Maximum Ratings.

Electrical Characteristics at $T_A = 25°C$

Symbol	Description	Device HLMP-	Min.	Typ.	Max.	Units	Test Conditions
$2\theta^1/_2$	Included Angle Between Half Luminous Intensity Points	All		60		Deg.	I_F = 10 mA See Note 1
λ_{PEAK}	Peak Wavelength	High Efficiency Red		635		nm	Measurement at Peak
		Orange		600			
		Yellow		583			
		Green		565			
		Emerald Green		558			
λ_d	Dominant Wavelength	High Efficiency Red		626		nm	See Note 2
		Orange		602			
		Yellow		585			
		Green		569			
		Emerald Green		560			
$\Delta\lambda_{1/2}$	Spectral Line Halfwidth	High Efficiency Red		40		nm	
		Yellow		36			
		Green		28			
		Emerald Green		24			
τ_s	Speed of Response	High Efficiency Red		90		ns	
		Orange		280			
		Yellow		90			
		Green		500			
		Emerald Green		3100			
C	Capacitance	High Efficiency Red		11		pF	V_F = 0; f = 1 MHz
		Orange		4			
		Yellow		15			
		Green		18			
		Emerald Green		35			
$R\theta_{J\text{-}PIN}$	Thermal Resistance	All		290		°C/W	Junction to Cathode Lead
V_F	Forward Voltage	HER/Orange	1.5	1.9	2.4	V	I_F = 10 mA
		Yellow	1.5	2.0	2.4		
		Green	1.5	2.1	2.7		
		Emerald Green		2.1	2.7		
V_R	Reverse Breakdown Voltage	All	5.0			V	I_R = 100 μA
η_V	Luminous Efficacy	High Efficiency Red		145		lumens watt	See Note 3
		Orange		380			
		Yellow		500			
		Green		595			
		Emerald Green		655			

Notes:
1. $\theta^1/_2$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
2. The dominant wavelength, λ_d, is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
3. Radiant intensity, I_e, in watts/steradian, may be found from the equation $I_e = I_v/\eta_v$, where I_v is the luminous intensity in candelas and η_v is the luminous efficacy in lumens/watt.

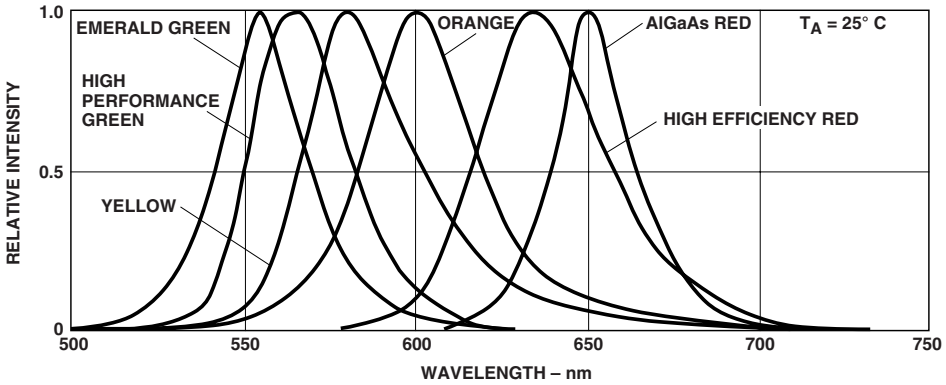


Figure 1. Relative intensity vs. wavelength.

T-1 High Efficiency Red, Orange Diffused Lamps

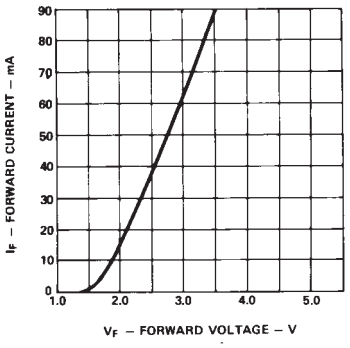


Figure 2. Forward current vs. forward voltage characteristics.

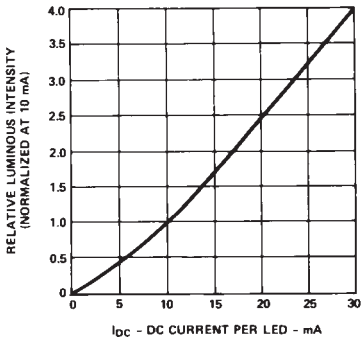


Figure 3. Relative luminous intensity vs. DC forward current.

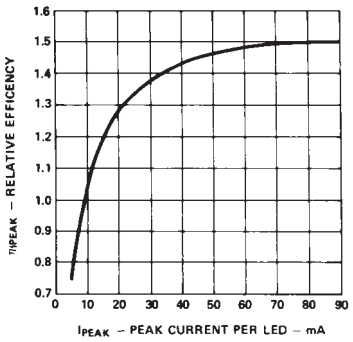


Figure 4. Relative efficiency (luminous intensity per unit current) vs. peak LED current.

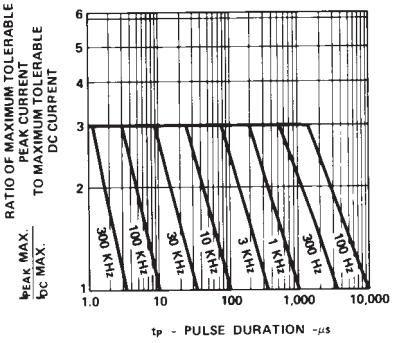


Figure 5. Maximum tolerable peak current vs. pulse duration. (I_{DC} MAX as per MAX ratings).

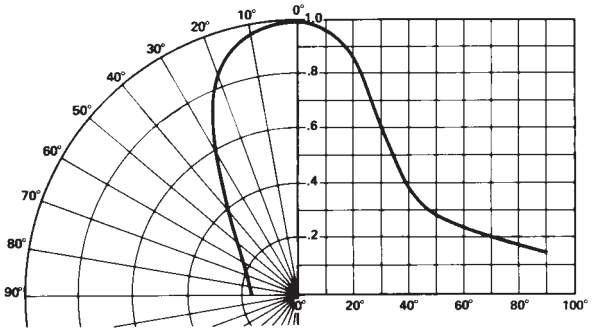


Figure 6. Relative luminous intensity vs. angular displacement.

T-1 Yellow Diffused Lamps

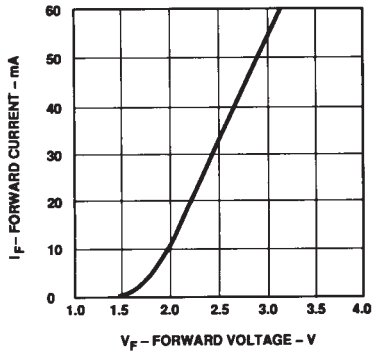


Figure 7. Forward current vs. forward voltage characteristics.

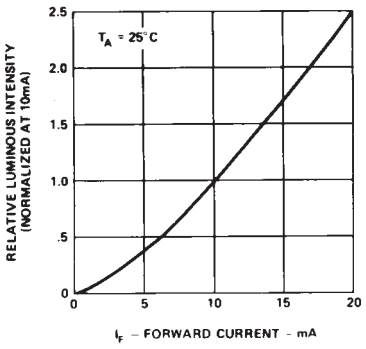


Figure 8. Relative luminous intensity vs. forward current.

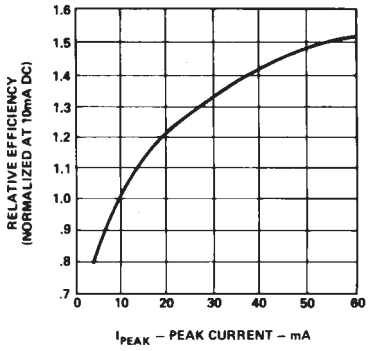


Figure 9. Relative efficiency (luminous intensity per unit current) vs. peak current.

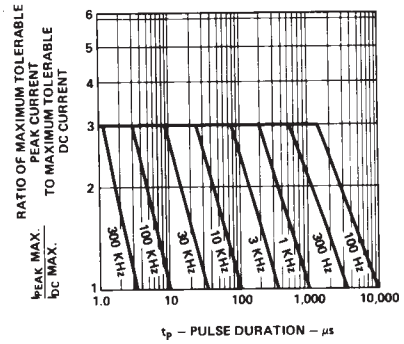


Figure 10. Maximum tolerable peak current vs. pulse duration. (I_{DC} MAX as per MAX ratings).

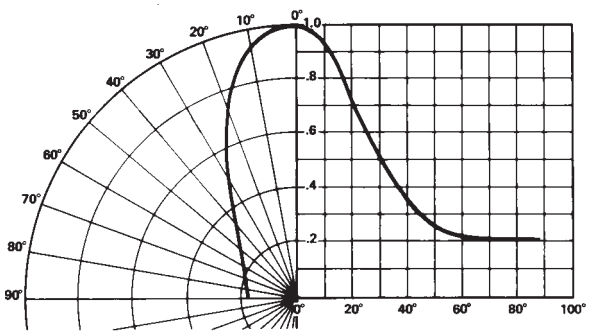


Figure 11. Relative luminous intensity vs. angular displacement.

T-1 Green/Emerald Green Diffused Lamps

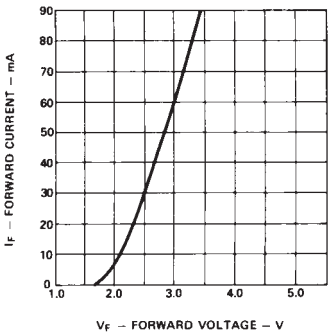


Figure 12. Forward current vs. forward voltage characteristics.

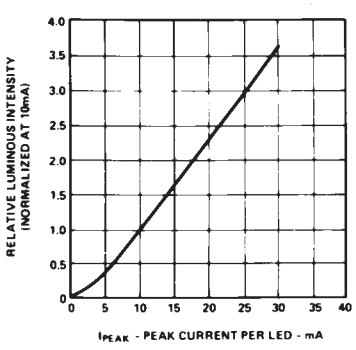


Figure 13. Relative luminous intensity vs. forward current.

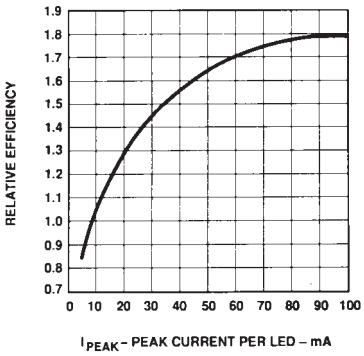


Figure 14. Relative efficiency (luminous intensity per unit vurrent) vs. peak LED current.

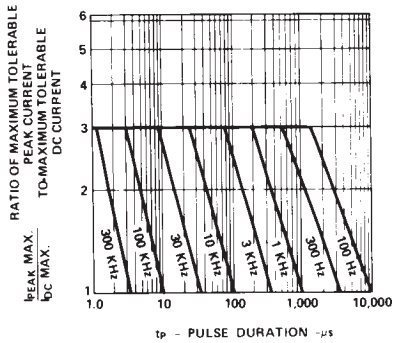


Figure 15. Maximum tolerable peak current vs. pulse duration. (I_{DC} MAX as per MAX ratings).

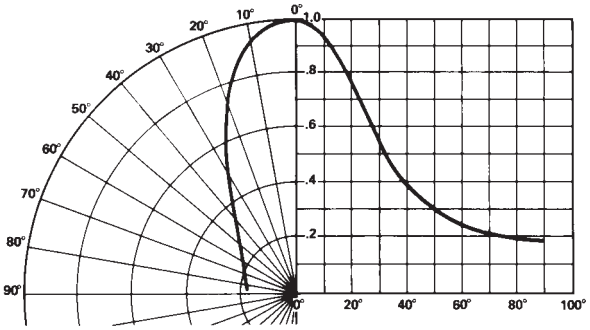


Figure 16. Relative luminous intensity vs. angular displacement.

Intensity Bin Limits

Color	Bin	Intensity Range (mcd) Min.	Max.
Red/Orange	D	2.4	3.8
	E	3.8	6.1
	F	6.1	9.7
	G	9.7	15.5
	H	15.5	24.8
	I	24.8	39.6
	J	39.6	63.4
	K	63.4	101.5
	L	101.5	162.4
	M	162.4	234.6
	N	234.6	340.0
	O	340.0	540.0
	P	540.0	850.0
	Q	850.0	1200.0
	R	1200.0	1700.0
	S	1700.0	2400.0
	T	2400.0	3400.0
	U	3400.0	4900.0
	V	4900.0	7100.0
	W	7100.0	10200.0
	X	10200.0	14800.0
	Y	14800.0	21400.0
	Z	21400.0	30900.0
Yellow	C	2.5	4.0
	D	4.0	6.5
	E	6.5	10.3
	F	10.3	16.6
	G	16.6	26.5
	H	26.5	42.3
	I	42.3	67.7
	J	67.7	108.2
	K	108.2	173.2
	L	173.2	250.0
	M	250.0	360.0
	N	360.0	510.0
	O	510.0	800.0
	P	800.0	1250.0
	Q	1250.0	1800.0
	R	1800.0	2900.0
	S	2900.0	4700.0
	T	4700.0	7200.0
	U	7200.0	11700.0
	V	11700.0	18000.0
	W	18000.0	27000.0

Intensity Bin Limits, continued

Color	Bin	Intensity Range (mcd) Min.	Max.
Green/ Emerald Green	A	1.1	1.8
	B	1.8	2.9
	C	2.9	4.7
	D	4.7	7.6
	E	7.6	12.0
	F	12.0	19.1
	G	19.1	30.7
	H	30.7	49.1
	I	49.1	78.5
	J	78.5	125.7
	K	125.7	201.1
	L	201.1	289.0
	M	289.0	417.0
	N	417.0	680.0
	O	680.0	1100.0
	P	1100.0	1800.0
	Q	1800.0	2700.0
	R	2700.0	4300.0
	S	4300.0	6800.0
	T	6800.0	10800.0
	U	10800.0	16000.0
	V	16000.0	25000.0
	W	25000.0	40000.0

Maximum tolerance for each bin limit is ± 18%.

Color Categories

Color	Category #	Lambda (nm) Min.	Max.
Emerald Green	9	522.5	555.5
	8	555.5	558.5
	7	558.5	561.5
	6	561.5	564.5
Green	6	561.5	564.5
	5	564.5	567.5
	4	567.5	570.5
	3	570.5	573.5
	2	573.5	576.5
Yellow	1	582.0	584.5
	3	584.5	587.0
	2	587.0	589.5
	4	589.5	592.0
	5	592.0	593.0
Orange	1	597.0	599.5
	2	599.5	602.0
	3	602.0	604.5
	4	604.5	607.5
	5	607.5	610.5
	6	610.5	613.5
	7	613.5	616.5
	8	616.5	619.5

Tolerance for each bin limit is ± 0.5 nm.

Mechanical Option Matrix

Mechanical Option Code	Definition
00	Bulk Packaging, minimum increment 500 pcs/bag
01	Tape & Reel, crimped leads, minimum increment 1800 pcs/bag
02	Tape & Reel, straight leads, minimum increment 1800 pcs/bag
A1	Right Angle Housing, uneven leads, minimum increment 500 pcs/bag
A2	Right Angle Housing, even leads, minimum increment 500 pcs/bag
BG	Tape & Reel, straight leads in 2K increment
BJ	Tape & Reel, straight leads in 2K increment
DD	Ammo Pack, straight leads in 2K increment
DJ	Ammo Pack, straight leads in 2K increment
EE	Ammo Pack, straight leads in 5K increment
R4	Tape & Reel, straight leads, counter clockwise, anode lead leaving the reel first
VA	Ammo Pack, horizontal leads in 2K increment
VB	Ammo Pack, horizontal leads in 2K increment
FG	Inventory Control for Customer IDI

Note:
All categories are established for classification of products. Products may not be available in all categories. Please contact your local Avago representative for further clarification/information.

Precautions

Lead Forming

- The leads of an LED lamp may be preformed or cut to length prior to insertion and soldering into PC board.
- If lead forming is required before soldering, care must be taken to avoid any excessive mechanical stress induced to LED package. Otherwise, cut the leads of LED to length after soldering process at room temperature. The solder joint formed will absorb the mechanical stress of the lead cutting from traveling to the LED chip die attach and wirebond.
- It is recommended that tooling made to precisely form and cut the leads to length rather than rely upon hand operation.

Soldering Conditions

- Care must be taken during PCB assembly and soldering process to prevent damage to LED component.
- The closest LED is allowed to solder on board is 1.59 mm below the body (encapsulant epoxy) for those parts without standoff.
- Recommended soldering conditions:

	Wave Soldering	Manual Solder Dipping
Pre-heat Temperature	105 °C Max.	–
Pre-heat Time	30 sec Max.	–
Peak Temperature	250 °C Max.	260 °C Max.
Dwell Time	3 sec Max.	5 sec Max.

- Wave soldering parameter must be set and maintained according to recommended temperature and dwell time in the solder wave. Customer is advised to periodically check on the soldering profile to ensure the soldering profile used is always conforming to recommended soldering condition.
- If necessary, use fixture to hold the LED component in proper orientation with respect to the PCB during soldering process.
- Proper handling is imperative to avoid excessive thermal stresses to LED components when heated. Therefore, the soldered PCB must be allowed to cool to room temperature, 25° C, before handling.
- Special attention must be given to board fabrication, solder masking, surface plating and lead holes size and component orientation to assure solderability.
- Recommended PC board plated through hole sizes for LED component leads:

LED Component Lead Size	Diagonal	Plated Through Hole Diameter
0.457 x 0.457 mm (0.018 x 0.018 inch)	0.646 mm (0.025 inch)	0.976 to 1.078 mm (0.038 to 0.042 inch)
0.508 x 0.508 mm (0.020 x 0.020 inch)	0.718 mm (0.028 inch)	1.049 to 1.150 mm (0.041 to 0.045 inch)

Note: Refer to application note AN1027 for more information on soldering LED components.

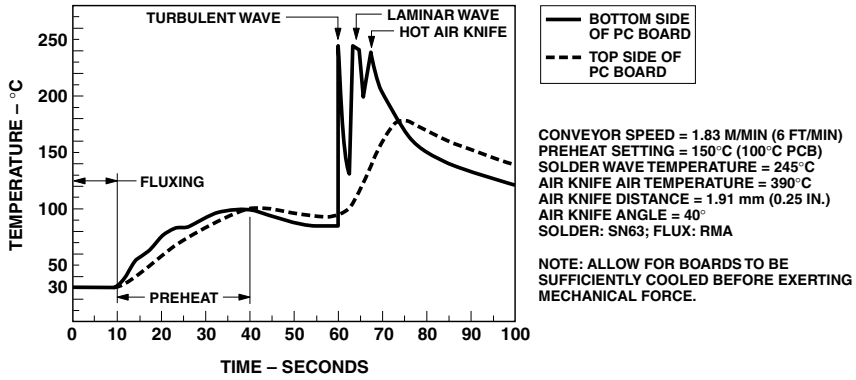


Figure 17. Recommended wave soldering profile.

For product information and a complete list of distributors, please go to our website: **www.avagotech.com**

 Obsoletes 5989-2808EN
5989-4252EN May 31, 2006

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